
HSB124S-J

Silicon Epitaxial Planar Diode for High Speed Switching

HITACHI

ADE-208-488(Z)
Rev 0

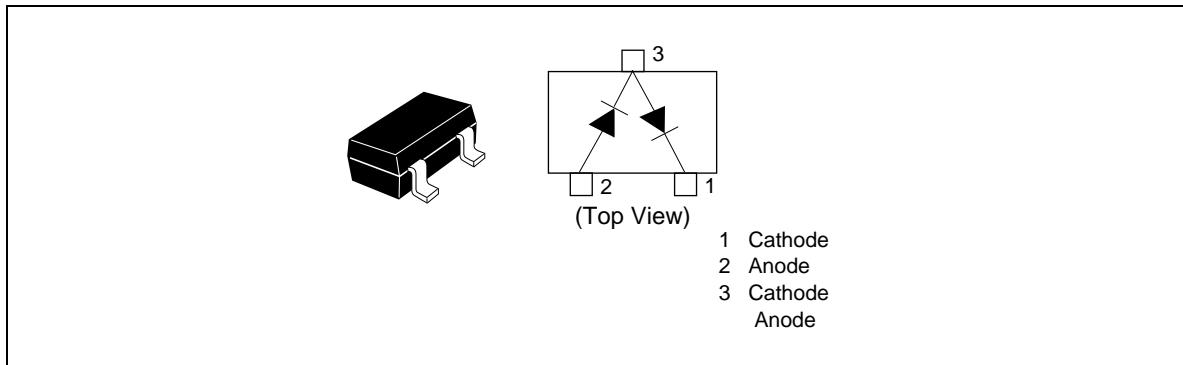
Features

- Low reverse current.($I_r = 0.01\mu A_{max}$)
- CMPAK package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HSB124S-J	A1	CMPAK

Outline



HSB124S-J

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Value	Unit
Peak reverse voltage	V _{RM}	85	V
Reverse voltage	V _R	80	V
Peak forward current	I _{FM} ^{*1}	300	mA
Non-Repetitive peak forward surge current	I _{FSM} ^{*2}	4	A
Average rectified current	I _O ^{*1}	100	mA
Junction temperature	T _j	125	°C
Storage temperature	T _{STG}	-55 to +125	°C

Notes: 1. Two device total.
2. Value at duration of 1μsec, two device total.

Electrical Characteristics (Ta = 25°C) *¹

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V _F	—	—	1.2	V	I _F = 100 mA
Reverse current	I _R	—	—	0.01	μA	V _R = 80V
Capacitance	C	—	—	4.0	pF	V _R = 0V, f = 1 MHz
Reverse recovery time	t _{rr}	—	—	100	ns	I _F = 10 mA, V _R = 6V, R _L = 50Ω

Note: 1. Per one device.

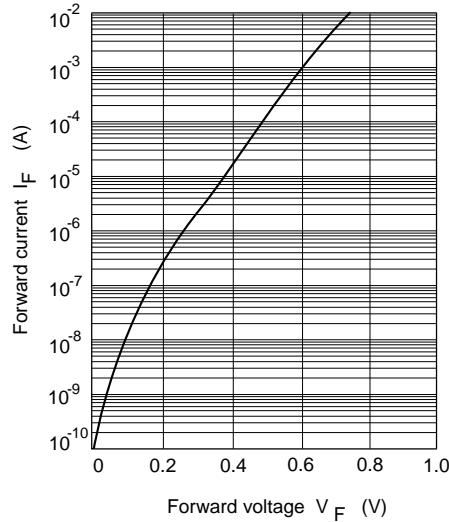
Main Characteristic

Fig.1 Forward current Vs. Forward voltage

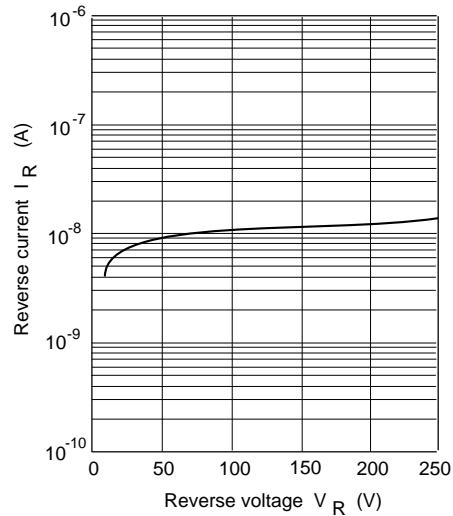


Fig.2 Reverse current Vs. Reverse voltage

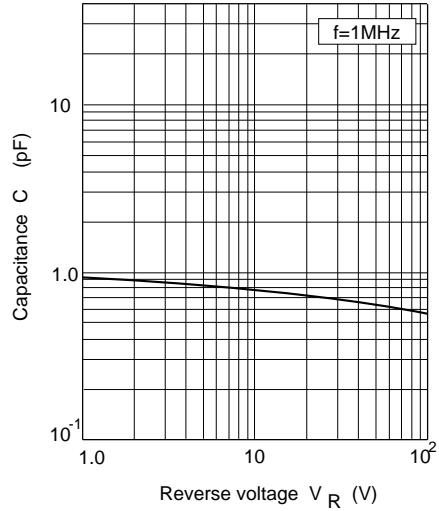


Fig.3 Capacitance Vs. Reverse voltage

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Package Dimensions

Unit : mm

